



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/055,298

Filed: January 23, 2002

For: METHOD AND APPARATUS FOR CONDUCTING HEAT IN A FLIP-CHIP

ASSEMBLY

Confirmation No.: 8949

Examiner: L. Thai

Group Art Unit: 2827

Attorney Docket No.: 2269-4376.1US

(99-0660.01/US)

Notice of Allowance Mailed:

May 19, 2004

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 11, 2004

Jace

Signature

Deborah L. Hedricks
Name (Type/Print)

phose enter. L.T. 1/13/05

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 15 of this paper.